

USB 2.0 High-Speed 3-Port Hub Controller

PRODUCT FEATURES

Data Brief

General Description

The SMSC 3-Port Hub is low power, OEM configurable, MTT (multi transaction translator) hub controller IC with 3 downstream ports for embedded USB solutions. The 3-port hub is fully compliant with the USB 2.0 Specification and will attach to an upstream port as a Full-Speed Hub or as a Full-/High-Speed Hub. The 3-Port Hub supports Low-Speed, Full-Speed, and High-Speed (if operating as a High-Speed Hub) downstream devices on all of the enabled downstream ports.

General Features

- Hub Controller IC with 3 downstream ports
- High-performance multiple transaction translator. MultiTRAK™ Technology Provides one transaction translator per port
- Enhanced OEM configuration options available through either a single serial i2C EEPROM, or SMBus Slave Port
- 36-pin (6x6mm) and 48-Pin (7x7mm) QFN lead-free, RoHS compliant packages
- Footprint compatible with USB2514 and USB2512 (36-pin QFN) to provide designers with flexibility regarding the quantity of USB expansion ports utilized without redesign

Hardware Features

- Low power operation
- Full Power Management with individual or ganged power control of each downstream port
- On-chip Power On Reset (POR)
- Internal 1.8V Voltage Regulator
- Fully integrated USB termination and Pull-up/Pull-down resistors
- On Board 24MHz Crystal Driver, Resonator or External 24/48MHz clock input
- USB host/device speed indicator. Per-port 3-color LED drivers that indicate the speed of USB host and device connection - hi-speed (480 Mbps), full-speed (12 Mbps), low-speed (1.5 Mbps) (48-pin QFN)
- Enhanced EMI rejection and ESD protection performance

OEM Selectable Features

- Customize Vendor ID, Product ID, and Device ID
- Select whether the hub is part of a compound device (When any downstream port is permanently hardwired to a USB peripheral device, the hub is part of a compound device)

- Flexible port mapping and disable sequence. Ports can be disabled/reordered in any order to support multiple product SKUs. Hub will automatically reorder the remaining ports to match the Host controller's numbering scheme
- Programmable USB differential-pair pin location
- Ease PCB layout by aligning USB signal lines directly to connectors
- Programmable USB signal drive strength. Recover USB signal integrity due to compromised system environment using 3-level driving strength resolution
- Select the presence of a permanently hardwired USB peripheral device on a port by port basis
- Configure the delay time for filtering the over-current sense inputs
- Configure the delay time for turning on downstream port power
- Configure the polarity of downstream port power control signals
- Indicate the maximum current that the 3-port hub consumes from the USB upstream port
- Indicate the maximum current required for the hub controller
- Supports Custom String Descriptor up to 31 characters in length for:
 - Product String
 - Manufacturer String
 - Serial Number String
- Pin Selectable Options for Default Configuration
 - Select Downstream Ports as Non-Removable Ports
 - Select Downstream Ports as Disabled Ports
 - Select Downstream Port Power Control and Over-Current Detection on a Ganged or Individual Basis
 - Select Downstream Port Power Control Polarity
 - Select USB Signal Drive Strength
 - Select USB Differential Pair Pin location
 - Select on-chip or off-chip voltage regulator mode

Applications

- LCD monitors and TVs
- Multi-function USB peripherals
- PC mother boards
- Set-top boxes, DVD players, DVR/PVR
- Printers and scanners
- PC media drive bay
- Portable hub boxes
- Mobile PC docking
- Embedded systems

ORDER NUMBERS:**USB2513-AEZG FOR 36 PIN, QFN LEAD-FREE ROHS COMPLIANT PACKAGE****USB2513-HZH FOR 48 PIN, QFN LEAD-FREE ROHS COMPLIANT PACKAGE**

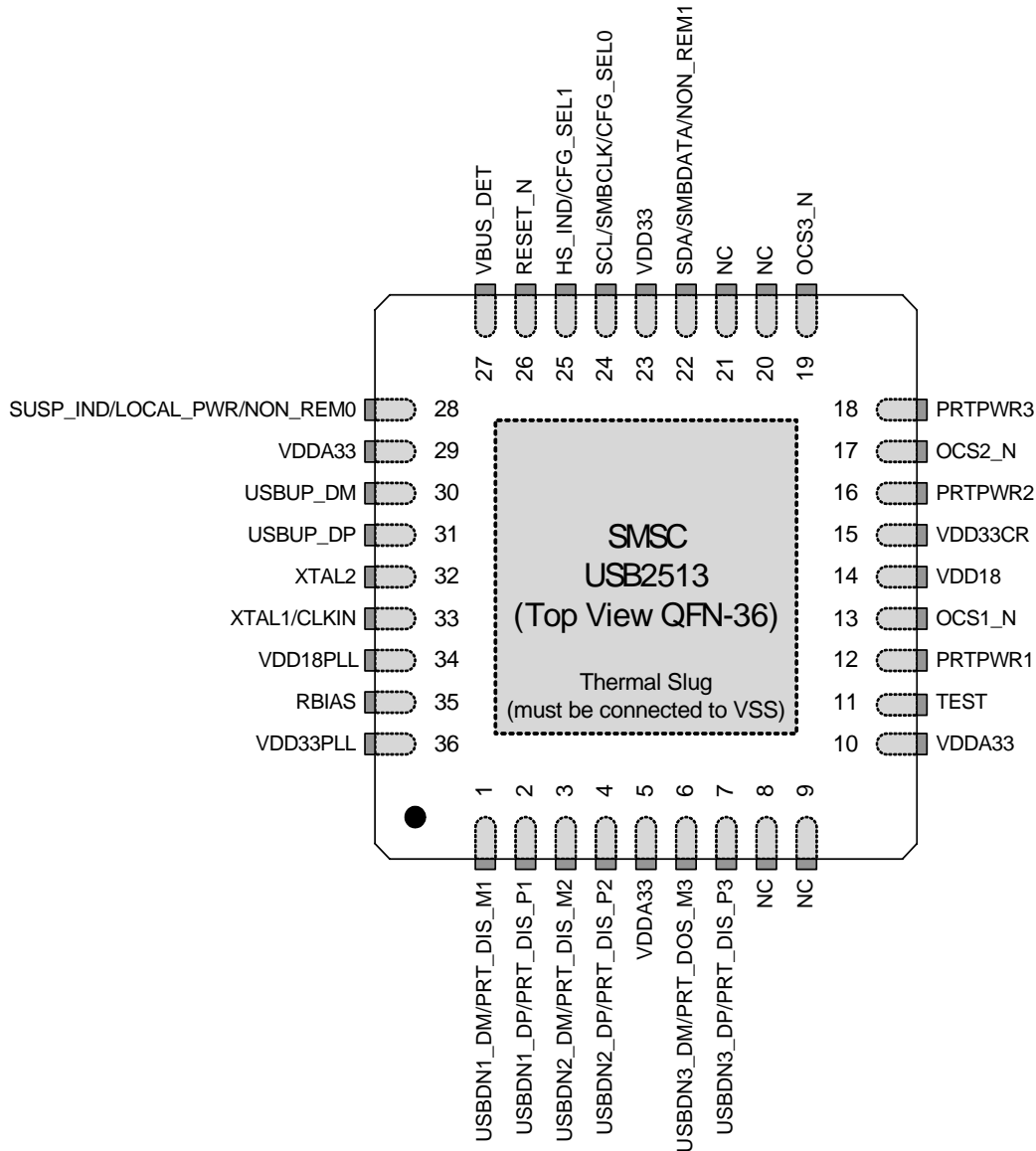
80 ARKAY DRIVE, HAUPPAUGE, NY 11788 (631) 435-6000, FAX (631) 273-3123

Copyright © 2007 SMSC or its subsidiaries. All rights reserved.

Circuit diagrams and other information relating to SMSC products are included as a means of illustrating typical applications. Consequently, complete information sufficient for construction purposes is not necessarily given. Although the information has been checked and is believed to be accurate, no responsibility is assumed for inaccuracies. SMSC reserves the right to make changes to specifications and product descriptions at any time without notice. Contact your local SMSC sales office to obtain the latest specifications before placing your product order. The provision of this information does not convey to the purchaser of the described semiconductor devices any licenses under any patent rights or other intellectual property rights of SMSC or others. All sales are expressly conditional on your agreement to the terms and conditions of the most recently dated version of SMSC's standard Terms of Sale Agreement dated before the date of your order (the "Terms of Sale Agreement"). The product may contain design defects or errors known as anomalies which may cause the product's functions to deviate from published specifications. Anomaly sheets are available upon request. SMSC products are not designed, intended, authorized or warranted for use in any life support or other application where product failure could cause or contribute to personal injury or severe property damage. Any and all such uses without prior written approval of an Officer of SMSC and further testing and/or modification will be fully at the risk of the customer. Copies of this document or other SMSC literature, as well as the Terms of Sale Agreement, may be obtained by visiting SMSC's website at <http://www.smisc.com>. SMSC is a registered trademark of Standard Microsystems Corporation ("SMSC"). Product names and company names are the trademarks of their respective holders.

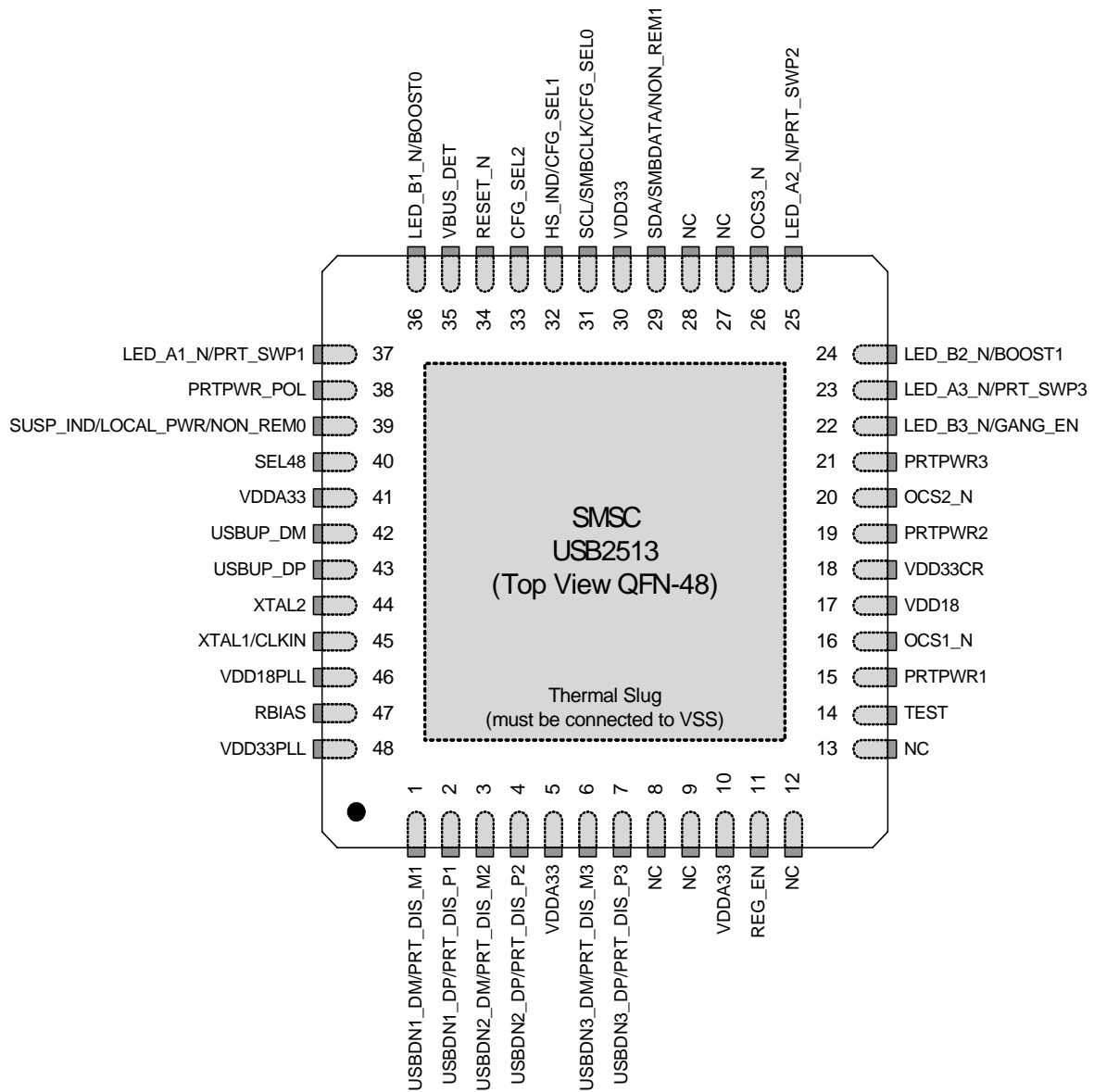
SMSC DISCLAIMS AND EXCLUDES ANY AND ALL WARRANTIES, INCLUDING WITHOUT LIMITATION ANY AND ALL IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, TITLE, AND AGAINST INFRINGEMENT AND THE LIKE, AND ANY AND ALL WARRANTIES ARISING FROM ANY COURSE OF DEALING OR USAGE OF TRADE. IN NO EVENT SHALL SMSC BE LIABLE FOR ANY DIRECT, INCIDENTAL, INDIRECT, SPECIAL, PUNITIVE, OR CONSEQUENTIAL DAMAGES; OR FOR LOST DATA, PROFITS, SAVINGS OR REVENUES OF ANY KIND; REGARDLESS OF THE FORM OF ACTION, WHETHER BASED ON CONTRACT; TORT; NEGLIGENCE OF SMSC OR OTHERS; STRICT LIABILITY; BREACH OF WARRANTY; OR OTHERWISE; WHETHER OR NOT ANY REMEDY OF BUYER IS HELD TO HAVE FAILED OF ITS ESSENTIAL PURPOSE, AND WHETHER OR NOT SMSC HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

Pin Configuration



Indicates pins on the bottom of the device.

Figure 1 USB2513 36-Pin QFN




 Indicates pins on the bottom of the device.

Figure 2 USB2513 48-Pin QFN

Block Diagram

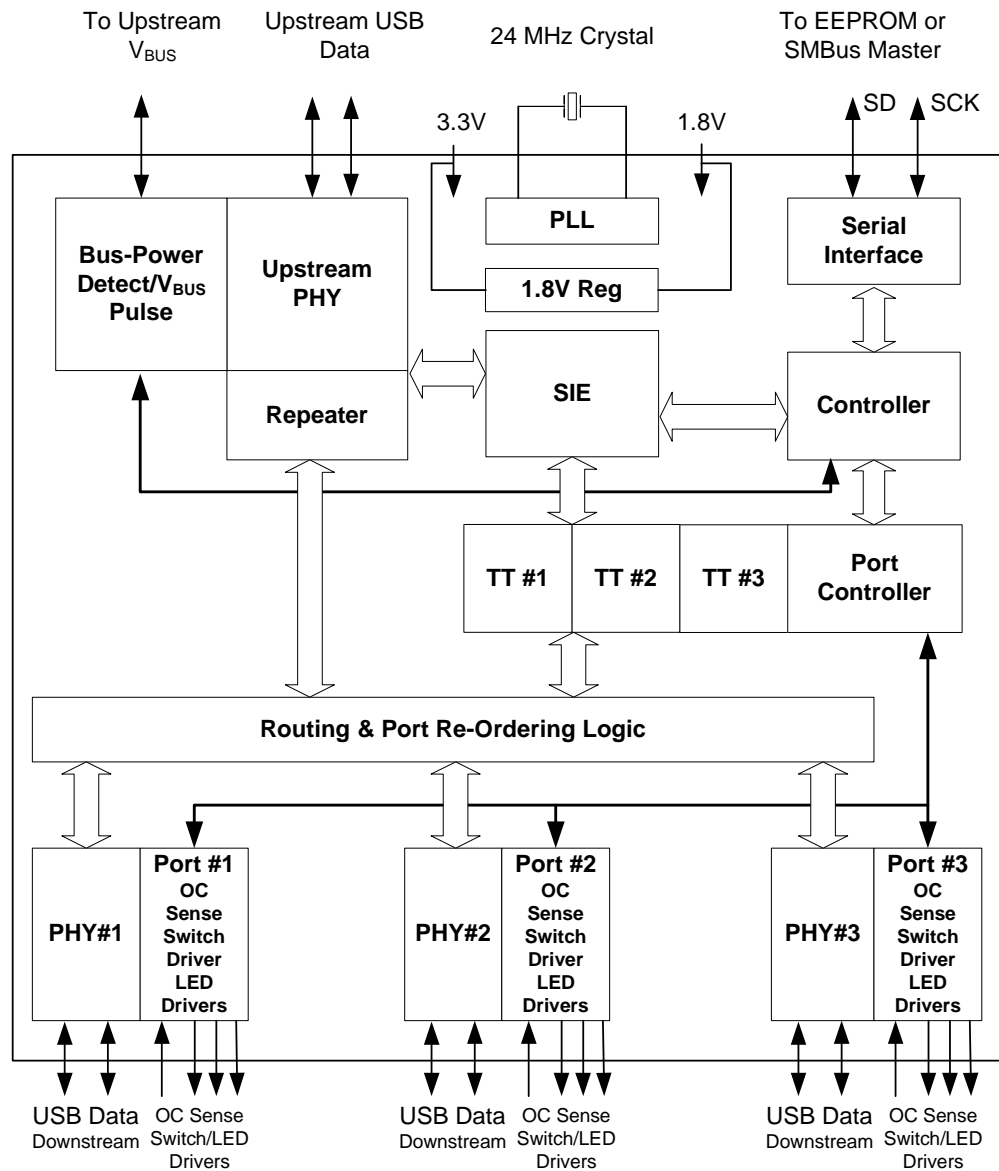


Figure 3 USB2513 Block Diagram

Package Outlines

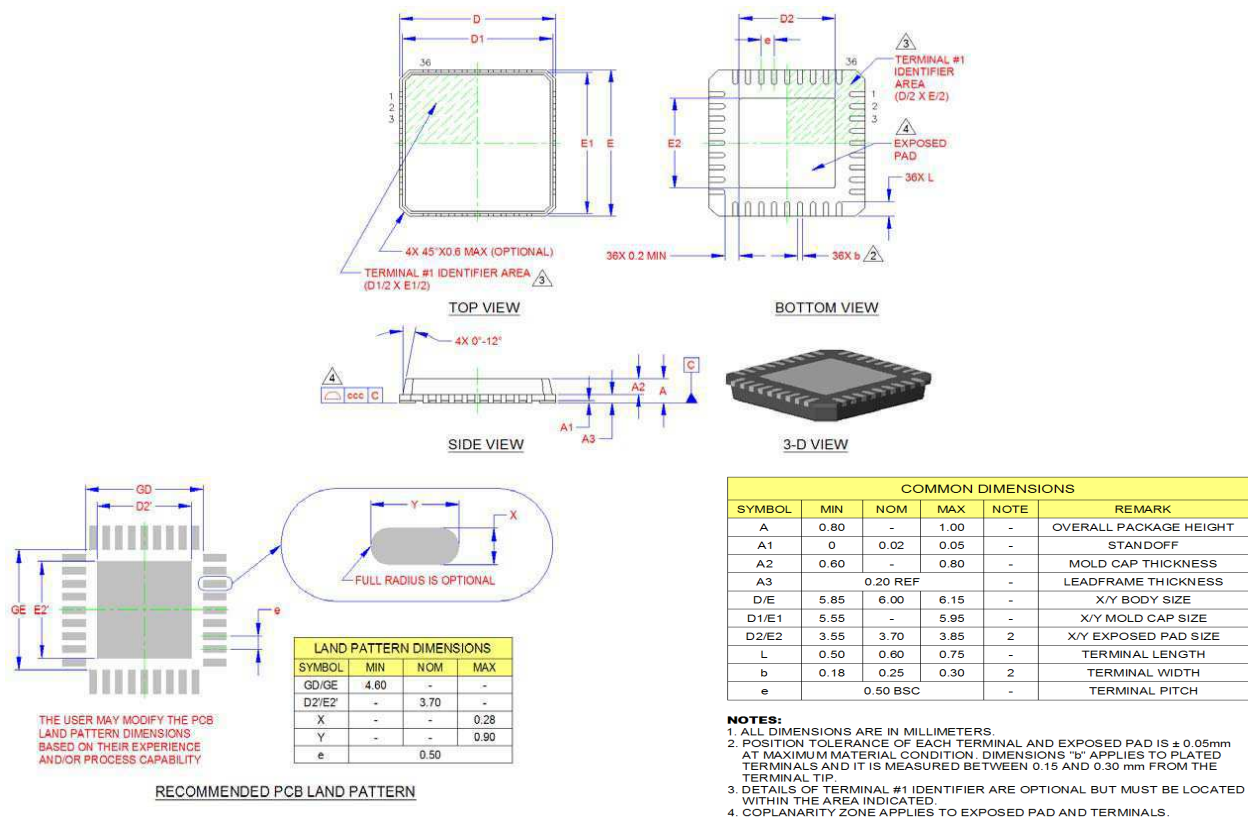
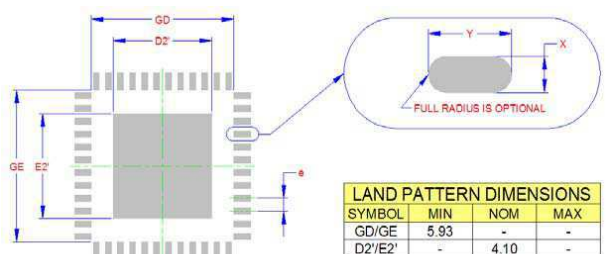
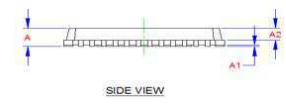
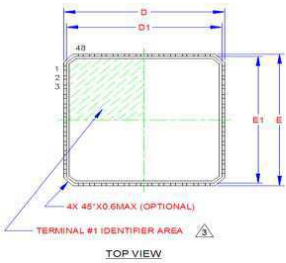
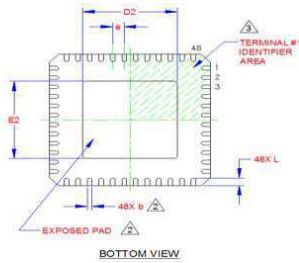


Figure 4 36-Pin QFN, 6x6mm Body, 0.5mm Pitch



THE USER MAY MODIFY THE PCB LAND PATTERN DIMENSIONS BASED ON THEIR EXPERIENCE AND/OR PROCESS CAPABILITY

LAND PATTERN DIMENSIONS			
SYMBOL	MIN	NOM	MAX
GD/GE	5.93	-	-
D2/E2*	-	4.10	-
X	-	-	0.28
Y	-	-	0.69
e	0.50		

RECOMMENDED PCB LAND PATTERN

COMMON DIMENSIONS					
SYMBOL	MIN	NOM	MAX	NOTE	REMARK
A	0.70	-	1.00	-	OVERALL PACKAGE HEIGHT
A1	0	0.02	0.05	-	STANDOFF
A2	-	-	0.90	-	MOLD CAP THICKNESS
D/E	6.85	7.00	7.15	-	X/Y BODY SIZE
D1/E1	6.55	-	6.95	-	X/Y MOLD CAP SIZE
D2/E2	4.00	4.10	4.20	2	X/Y EXPOSED PAD SIZE
L	0.30	-	0.50	-	TERMINAL LENGTH
b	0.18	0.25	0.30	2	TERMINAL WIDTH
e	0.50 BSC			-	TERMINAL PITCH

- NOTES:**
- ALL DIMENSIONS ARE IN MILLIMETER.
 - POSITION TOLERANCE OF EACH TERMINAL AND EXPOSED PAD IS $\pm 0.05\text{mm}$ AT MAXIMUM MATERIAL CONDITION. DIMENSIONS "b" APPLIES TO PLATED TERMINALS AND IT IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL TIP.
 - DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE AREA INDICATED.

Figure 5 48-Pin QFN, 7x7mm Body, 0.5mm Pitch